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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

YASUDA et al.

Art Unit: Unassigned

Application No. Unassigned

Examiner: Unassigned

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For:

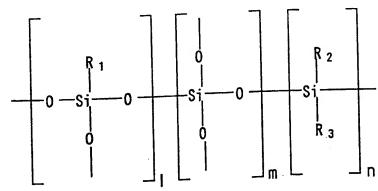
SENSOR ELEMENT AND METHOD OF FABRICATING THEREOF

PENDING CLAIMS AFTER ENTRY OF PRELIMINARY AMENDMENT

1. A sensor element comprising:

sensor substrate;

- a sensing portion supported by the sensor substrate; and
- a resin film between the sensor substrate and the sensing portion.
- 2. The sensor element according to claim 1, wherein the sensing portion has a microfine wiring pattern.
- 3. The sensor element according to claim 2, wherein the microfine wiring pattern comprises plural wiring patterns adjacent each other.
- 4. The sensor element according to claim 1, wherein the resin film is a cured polymer film selected from the group consisting of silicone polymers, polyimide polymers, polyimide silicone polymers, polyarylene ether polymers, bisbenzocyclobutene polymers, polyquinoline, perfluorohydrocarbon, fluorocarbon polymers, and aromatic hydrocarbon polymers.
- 5. The sensor element according to claim 4, wherein the polymer is a photo-curing polymer.
- 6. The sensor element according to claim 1, wherein the cured polymer film is a silicone polymer represented by the general formula (1)



wherein R_1 , R_2 , and R_3 may be the same or different, are selected from the group consisting of an aryl group, a hydrogen atom, an aliphatic alkyl group, a hydroxyl group, a trialkylsilyl group, and a functional group having an unsaturated bond, 1, m, and n are integers and at least 0, and the silicone polymer has a weight-average molecular weight of not less than 1,000.

7. The sensor element according to claim 1, wherein the resin film is a cured film of a silicone polymer represented by the general formula

$$\begin{array}{c|c}
R_{3}0 & & & \\
\hline
R_{4}0 & & & \\
\hline
R_{2} & & \\
\hline
R_{5}$$

wherein R_1 and R_2 may be same or different, and are selected from the group consisting of an aryl group, a hydrogen atom, an aliphatic alkyl group, and a functional group having an unsaturated bond, R_3 , R_4 , R_5 , and R_6 may be same or different, and are selected from the group consisting of a hydrogen atom, an aryl group, an aliphatic alkyl group, a trialkylsilyl group, and a functional group having an unsaturated bond, and n is an integer, and the silicone polymer has a weight-average molecular weight of not less than 1,000.

- 8. The sensor element according to claim 4, wherein the resin film comprises plural layers and each of the layers comprises a cured polymer film of a different cured polymer.
- 9. The sensor element according to claim 8, wherein each of the layers comprises a cured polymer having different molecular weight.
- 10. The sensor element according to claim 9, wherein the layers include a layer of a cured polymer film comprising a silicone polymer having a weight-average molecular weight of not less than 100,000 and a layer of a cured polymer film comprising a silicone polymer having a weight-average molecular weight of not more than 100,000.
- 11. The sensor element according to claim 8, wherein an uppermost layer of the layers comprises a cured polymer film of a photo-curing polymer.
- 12. The sensor element according to claim 1, wherein the sensor element is selected from the group consisting of a magnetoresistance sensor, an air flow sensor, an acceleration sensor, a pressure sensor, a yaw rate sensor, and an image sensor.
 - 13. A method of fabricating a sensor element, comprising:

applying a solution including a thermosetting polymer to a sensor substrate to form a polymer film;

heating the polymer film to a temperature not lower than a fusing temperature and lower than a curing temperature of the thermosetting polymer;

heating the polymer film to a temperature not lower than the curing temperature to cure the resin film; and forming a sensor element on the resin film after curing of the resin film.

14. The method of fabricating a sensor element according to claim 13, wherein the thermosetting polymer is selected from the group consisting of a silicone polymer, a polyimide polymer, a polyimide silicone polymer, a polyarylene ether polymer, a bisbenzocyclobutene polymer, a polyquinoline polymer, a perfluorohydrocarbon polymer, a fluorocarbon polymer, and an aromatic hydrocarbon polymer.